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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

THOMAS FEUDEL CHRISTIAN KRUEGER LUTZ HERRMANN

Serial No.: 10/602,583

Filed: June 24, 2003

For: SEMICONDUCTOR DEVICE HAVING AN IMPROVED STRAINED SURFACE

LAYER AND METHOD OF FORMING A STRAINED SURFACE LAYER IN A

SEMICONDUCTOR DEVICE

Examiner: William M. Brewster

Group Art Unit: 2823

Att'y Docket: 2000.106100/DE0107

Customer No.: 23720

RESPONSE TO FINAL OFFICE ACTION DATED JUNE 21, 2004

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

CERTIFICATE OF MAILING 37 C.F.R 1.8

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date below:

June 29, 2004

Date

This paper is submitted in response to the Final Office Action dated June 21, 2004, for

which the three-month date for response is September 21, 2004.

No fees are believed to be due in connection with the present paper. However, should any fees be required under 37 C.F.R. §§ 1.16 to 1.21, the Director is authorized to deduct such

fees from Advanced Micro Devices, Inc. Deposit Account No. 01-0365/DE0107. In the event the monies in that account are insufficient, the Director is authorized to withdraw funds from Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.106100.

Reconsideration of the application in view of the following amendments and remarks is respectfully requested.